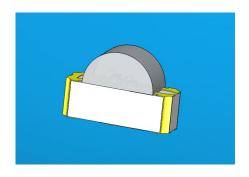


DATASHEET

SMD B

12-22SURSYGC/S530-A3/E2/TR8



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- · Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH.
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm)

Description

- The 12-22 SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

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Applications

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- · General use.

Device Selection Guide

(Chip	Emitted Color	Desin Color
Туре	Materials	Emitted Color	Resin Color
SUR	AlGaInP	Brilliant Red	Water Clear
SYG	AlGalnP	Brilliant Yellow Green	Water Clear

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V_R	5	V	
Forward Current	I _F	SUR : 25 SYG : 25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	SUR : 60 SYG : 60	mA	
Power Dissipation	Pd	SUR : 60 SYG : 60	mW	

LifecyclePhase:



Operating Temperature	T _{opr}	-40 ~ +85
Storage Temperature	Tstg	-40 ~ +90
Electrostatic Discharge	ESD _{HBM}	2000 V
Soldering Temperature	T _{sol}	Reflow Soldering: 260 for 10 sec. Hand Soldering: 350 for 3 sec.

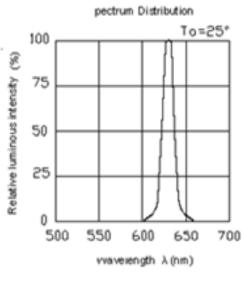
Electro-Optical Characteristics (Ta=25)

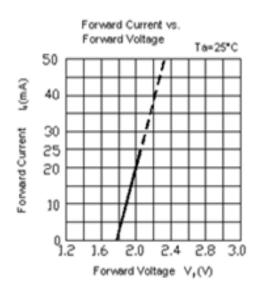
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
	lv					
Luminaua Intonaitu	SUR	36	54		mcd	
Luminous Intensity	SYG	21	28		mou	
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA
	p					
5	SUR		632			
Peak Wavelength	SYG		575		nm	

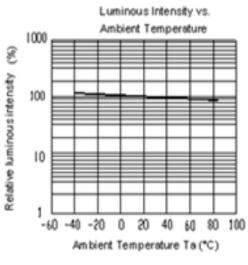
Dominant Wavelength	d SUR		624		nm	
	SYG		573			
Spectrum Radiation Bandwidth	SUR		20		nm	
	SYG		20			
	V_F SUR	1.7	2.0	2.4		
Forward Voltage	SYG	1.7	2.0	2.4	V	
	I _R			40		
Reverse Current	SUR SYG			10 10	μΑ	V _R =5V

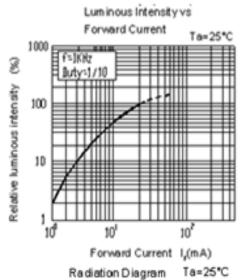


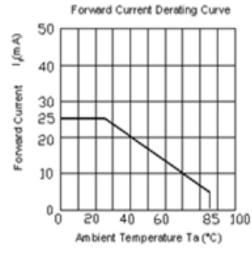
SUR

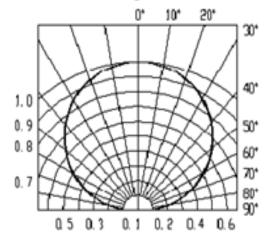








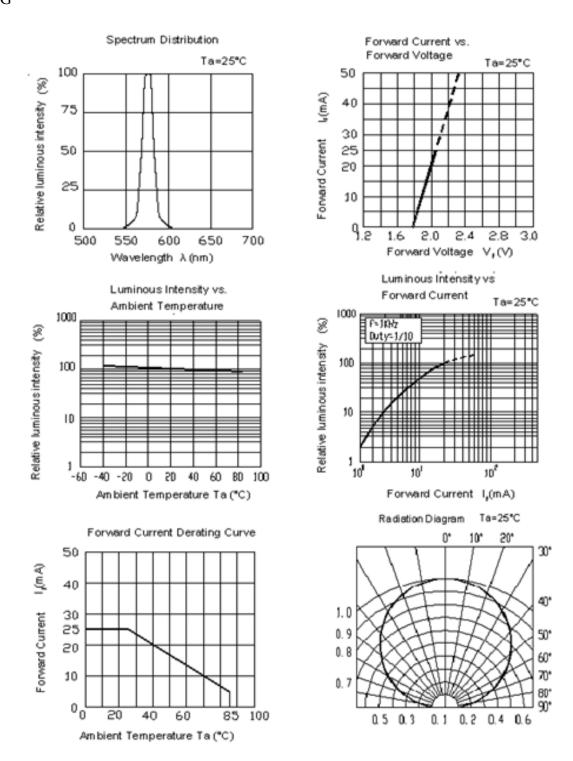






Typical Electro-Optical Characteristics Curves

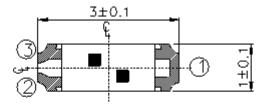
SYG



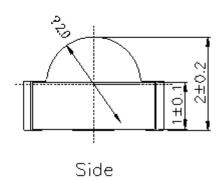
LifecyclePhase:

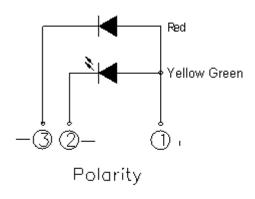


Package Dimension

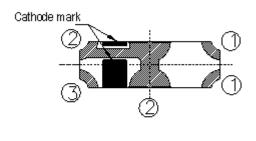


Тор

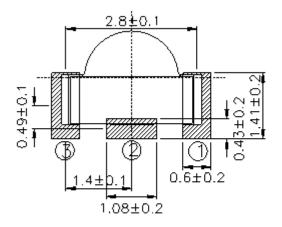




Recommend Sodering Pad



Bottom



Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ±0.1mm. Unit = mm

LifecyclePhase:



Moisture Resistant Packing Materials

Label Explanation

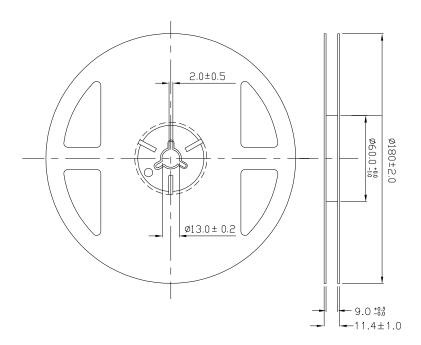


- CPN: Customer's Product Number
- P/N: Product Number
- · QTY: Packing Quantity
- · CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength

Rank

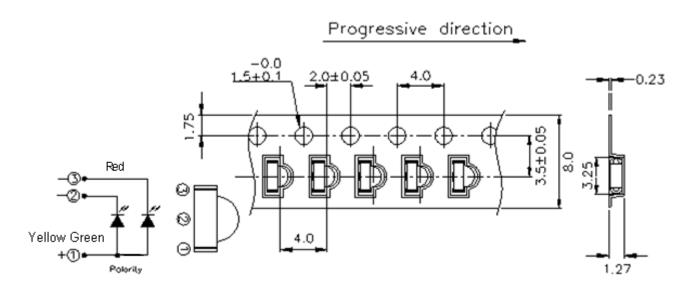
- REF: Forward Voltage Rank
- · LOT No: Lot Number

Reel Dimensions



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

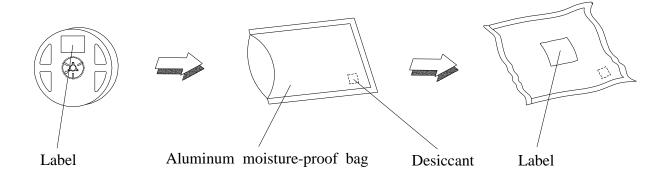
Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ±0.1mm, Unit = mm



Moisture Resistant Packaging



Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package: The LEDs should be kept at 30 or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30 or less and 60% RH or less.

If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

10

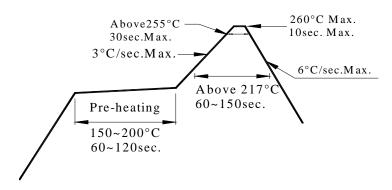
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Baking treatment: 60±5 for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile

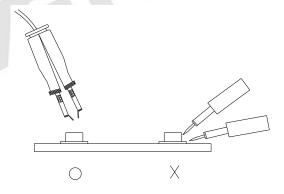


- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.
- 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



Application Restrictions



High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.



LifecyclePhase:

单击下面可查看定价,库存,交付和生命周期等信息

>>Everlight(亿光)